



Honeywell Thermal Interface Materials Reliability Report

PTM7000

Rev.F

Honeywell



Executive Summary

Honeywell PTM7000, a high thermal conductive Phase Change Material (PCM) in pad format, was designed to minimize thermal resistance at interfaces and has the great excellent long term reliability.

Based on a novel polymer PCM system, this material exhibits excellent wetting at interfaces during typical operating temperature range, resulting in very low surface contact resistance.

A proprietary filler material provides high thermal conductivity $6.5\text{W/m}\cdot\text{K}$ and a low thermal impedance ($<0.06^\circ\text{C cm}^2/\text{W}$), suitable for high performance IC devices.

Conclusion :

PTM7000 has excellent thermal stability after different long term reliability tests including HAST 96hrs and High Temperature Baking 1000hrs, T/C-B 1000cycles .

Introduction

- **Purpose**

- This test is intended to provide the thermal performance stability data of Honeywell Thermal Interface Material via different accelerated conditions.

- **Test Method**

- Thermal Impedance via Laser Flash Test (ASTM E1461)

- **Test Procedure**

- 12x12mm standard dimension TIM is prepare for TI test.
- TIM is applied both Cu plates as sandwich structure.
- 35 psi pressure pre-applied on the sandwich structure before test.
- Measure TI data before and after each test read point.

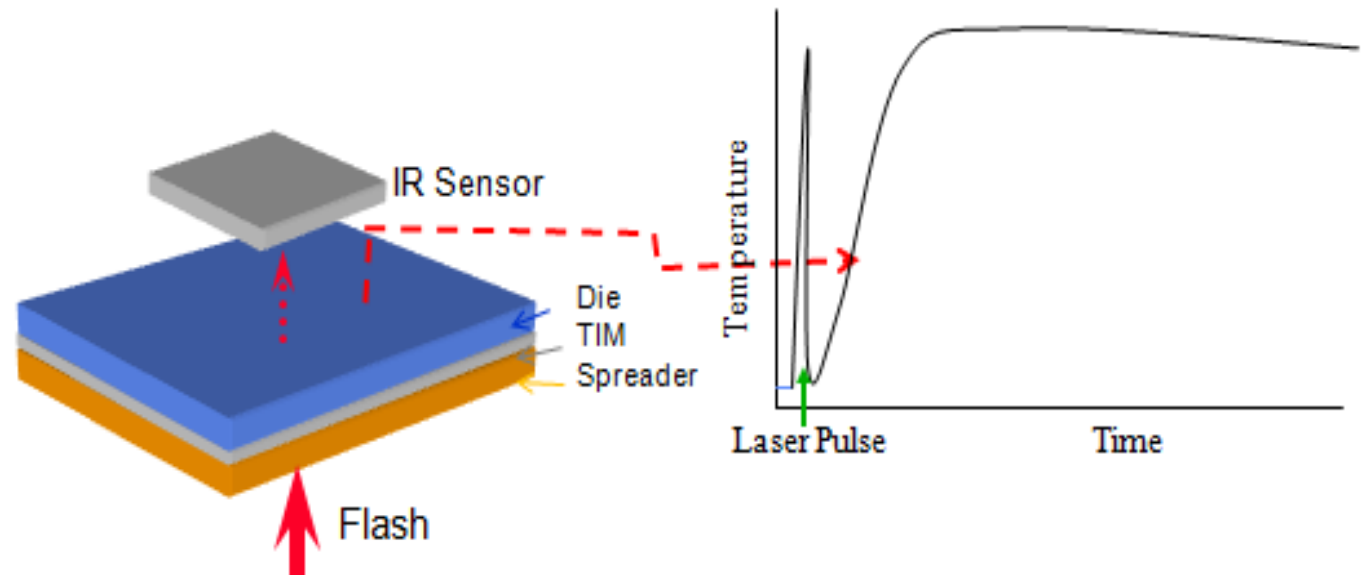
- **Test Items/Condition**

- Highly-Accelerated Stress Test (HAST) 96hrs
- Temperature Cycling Test 1000x
- High Temperature Baking Test 1000hrs

Thermal Impedance Test Method: Laser Flash



Netzsch Laser Flash™



$$k = (\alpha)(C_p)(\rho)$$

k = Thermal Conductivity (W/cmK)

α = Thermal Diffusivity (cm²/s)

$$\alpha = 0.13879L^2 / t_{1/2}$$

L = specimen thickness, meter

$t_{1/2}$ = the time required for the temperature rise to reach 50% percent of ΔT_{max}

C_p = Specific Heat Capacity (J/gK)

ρ = Density (g/cm³)

ASTM E1461

- **Thermal Impedance Both Ni-plated Cu Surfaces**
 - Includes the CTE mismatch
 - Includes actual surface finish
- **Typical Coupons:**
 - Ni-plate copper, 0.5"X0.5"X0.03"
- **Suitable for Accelerated Life Test**

Reliability Test Condition

- **Highly-Accelerated Stress Test (HAST)**

- Standard: JESD22-A110-B
- Testing Condition: 130°C, 85%RH, **96 hours**
- Chamber supplier: ESPEC EHS-411M
- Objective: Accelerate corrosive impact of high humidity and temperature on the thermal performance of the test structure



HAST chamber

- **Temperature Cycling Test**

- Standard: JESD22-A104C
- Testing Condition: -55°C to 125°C (TCB), **1000cycles**
- Chamber supplier: ESPEC EGNZ12-7.5CWL
- Objective: Determine the resistance of TIM to extremes of high and low temperatures, and its ability to withstand cyclical stresses



TC chamber

- **High Temperature Baking**

- Standard: JESD22-A103
- Testing Condition: 150°C, **1000 hours**
- Oven supplier: BINDER
- Objective: Accelerate changes in TIM's material and performance characteristics relative to prolonged and elevated temperature

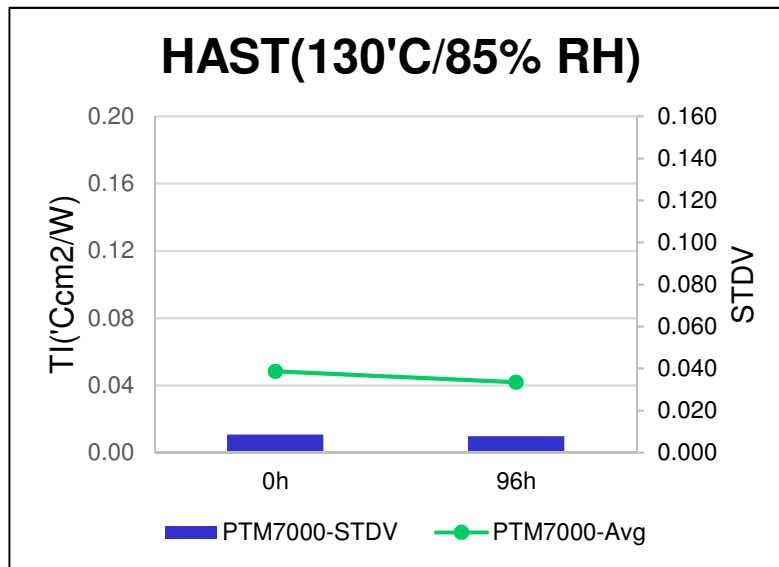


Oven

Highly-Accelerated Stress Test (HAST)

Test Condition: 130 °C, 85%RH, 96 hours

- Standard: JESD22-A110-B
- Testing Condition: 130 °C, 85%RH, 96 hours
- Objective: Accelerate corrosive impact of high humidity and temperature on the thermal performance of the test structure
- Sample size: 4 pcs samples.



HAST chamber

PTM7000 remain reliable up to 96hrs for HAST

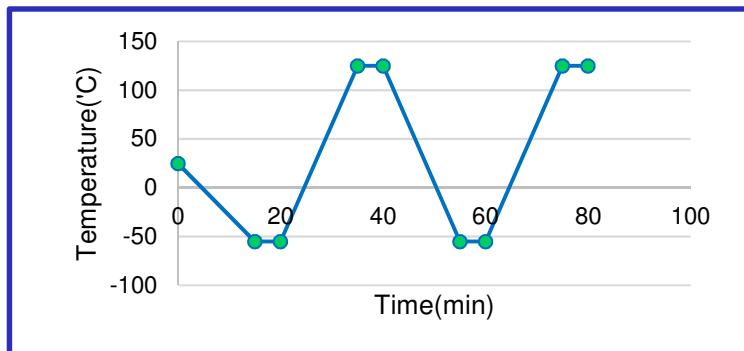
Temperature Cycling Test Testing

Test Condition: -55~+125°C, 1000 cycles

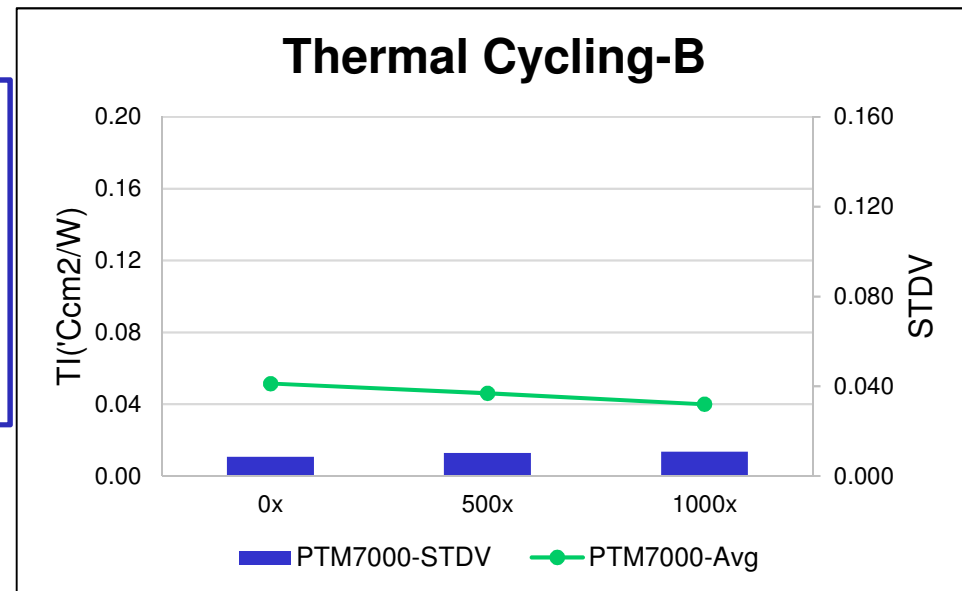
- Standard: JESD22-A104C
- Testing Condition: -55°C to 125°C (TCB), 1000 cycles
- Objective: Determine the resistance of TIM to extremes of high and low temperatures, and its ability to withstand cyclical stresses
- Sample size: 4 pcs samples.



TC chamber



- Ramp time: 15mins
- Dwelling time @ -55°C and 125°C: 5mins
- Every cycle: 40mins

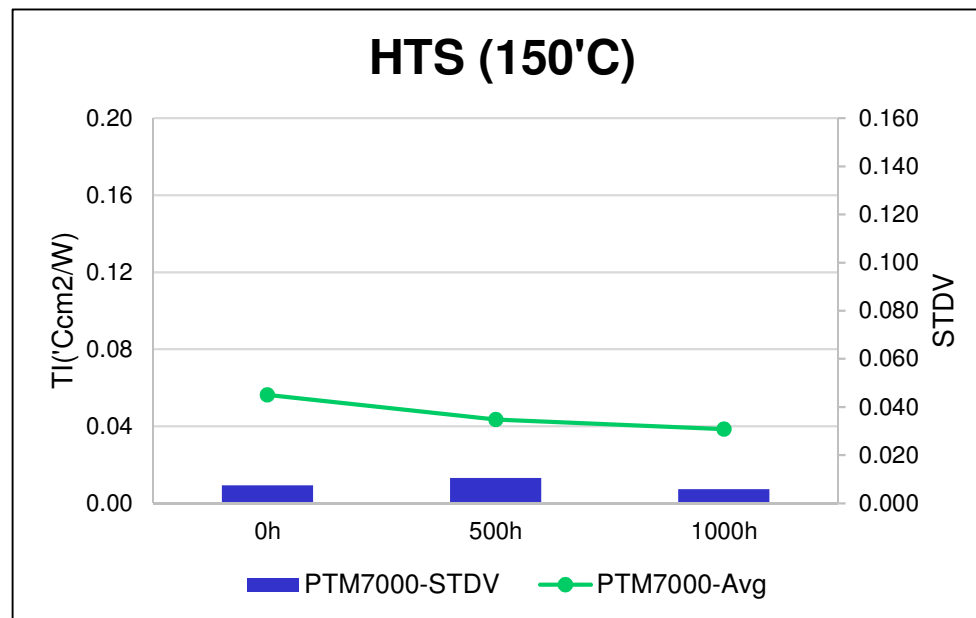


PTM7000 remain reliable up to 1000 cycles for thermal cycling test.

High Temperature Baking

Testing Condition: 150°C, 1000 hours

- The samples were placed into the test chamber at 150°C for 1000 hours. After the 500 hours, the sandwich samples were taken out and left at room temperature. Measurements of the samples for each were taken after a minimum of 2 hours. The process was repeated every 500hrs to 1000 hours.
- Sample size: 4 pcs samples.



PTM7000 remain reliable up to 1000hrs for 150°C baking

THANK YOU

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